

Product/process change notification

PCN N° 2024-099-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Capacity extension for dedicated products in TO247 packages for assembly and final test location to Huayi Microelectronics, China

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **2024-11-21**
- Infineon aligns with the widely recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

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Chairman of the Supervisory Board Dr. Herbert Diess

Management Board Jochen Hanebeck (CEO), Elke Reichart, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg

Registered office Neubiberg Commercial register Amtsgericht München HRB 126492

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- **Products affected** Please refer to attached affected product list
PCN_2024-099-A_[customer-no].pdf

- **Detailed change information**

Subject	Capacity extension for dedicated products in TO247 packages for assembly and final test location to Huayi Microelectronics, China.	
Reason	Extension of assembly and final test sites for additional capacity to ensure the continuity of supply and flexible manufacturing.	
Description	<u>Old</u>	<u>New</u>
Assembly & Final Test location	<ul style="list-style-type: none"> - Rectificadores Internacionales, S.A. de C.V., Tijuana, Mexico - Great Team Backend Foundry Ltd., China 	<ul style="list-style-type: none"> - Great Team Backend Foundry Ltd., China - Huayi Microelectronics Co.,Ltd., China
Mould Compound	<ul style="list-style-type: none"> - Kyocera KEG300 - Sumitomo EME-E500 	<ul style="list-style-type: none"> - Sumitomo EME-E500
1st OPN suffix digit	<ul style="list-style-type: none"> - "<u>A</u>" (Halogen-free, RoHS compliant, <u>not</u> Totally Lead-free) 	<ul style="list-style-type: none"> - "<u>X</u>" (Halogen-free, RoHS compliant, Totally Lead-free)
Full OPN e.g.	IRFP90N20DPBF <u>A</u> KMA1	IRFP90N20DPBF <u>X</u> KMA1
Marking on Device	<ul style="list-style-type: none"> - for details, see 3_cip24099_A.pdf 	

- **Product identification** Traceability is assured via datecode, marking on device and SP/OPN numbers (for details, see 4_cip24099_A.pdf).

- **Impact of change** **No** impact on electrical performance. **No** change in form, fit and function. Quality and reliability verified by qualification.

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- Attachments

PCN_2024-099-A_[customer-no].pdf	affected product list
2_cip24099_A.pdf	qualification report
3_cip24099_A.pdf	customer info package
4_cip24099_A.pdf	SP/OPN list

- Time schedule

- Final qualification report	available
- First samples available	on request
- Intended start of delivery	2025-04-30

If you have any questions, please do not hesitate to contact your local sales office.